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- State-of-the-Art BiCMOS Design Significantly Reduces I_{CCZ}
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- 3-State B Outputs Sink 48 mA or 64 mA and Source 12 mA or 15 mA
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic 300-mil DIPs (NT)

description

The SN74BCT657 contains eight noninverting transceivers with 3-state outputs and an 8-bit parity generator/checker. It is intended for busoriented applications.

(TOP VIEW) T/R 24 🛮 ŌE 23 B1 A1 ∏ 2 A2 🛮 3 22 B2 21 B3 A3 Π 4 20 **1** B4 A4 ∏ 5 19 GND A5 **∏** 6 18 GND V_{CC} [] 7 17 B5 A6 | 8 16**∏** B6 A7 🛮 9 A8 **∏** 10 15 **∏** B7 ODD/EVEN 11 14 B8 ERR 13 PARITY 12

DW OR NT PACKAGE

The transmit/receive (T/\overline{R}) input determines the direction of the data flow through the bidirectional transceivers. When T/\overline{R} is high, data is transmitted from the A port to the B port. When T/\overline{R} is low, data is received at the A port from the B port.

When the output-enable (\overline{OE}) input is high, both the A and B ports are placed in a high-impedance state (disabled). The ODD/ \overline{EVEN} input allows the user to select between odd or even parity systems.

When transmitting from A port to B port $(T/\overline{R} \text{ high})$, PARITY is an output from the generator/checker. When receiving from B port to A port $(T/\overline{R} \text{ low})$, PARITY is an input.

When transmitting (T/R high), the parity-select (ODD/EVEN) input is made high or low as appropriate. The A port is then polled to determine the number of high bits. The PARITY output goes to the logic state determined by the parity-select (ODD/EVEN) input and the number of high bits on A port. When ODD/EVEN is low (for even parity) and the number of high bits on A port is odd, the PARITY will be high, transmitting even parity. If the number of high bits on A port is even, the PARITY will be low, keeping even parity.

When in the receive mode $(T/\overline{R} \text{ low})$, the B port is polled to determine the number of high bits. If ODD/ \overline{EVEN} is low (for even parity) and the number of highs on B port is as follows:

- Odd and the PARITY input is high, then ERR will be high signifying no error.
- Even and the PARITY input is high, then ERR will be low indicating an error.

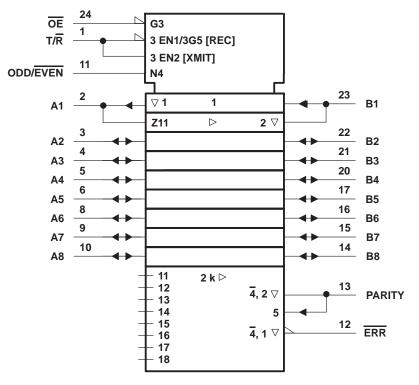
The SN74BCT657 is characterized for operation from 0°C to 70°C.

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FUNCTION TABLE

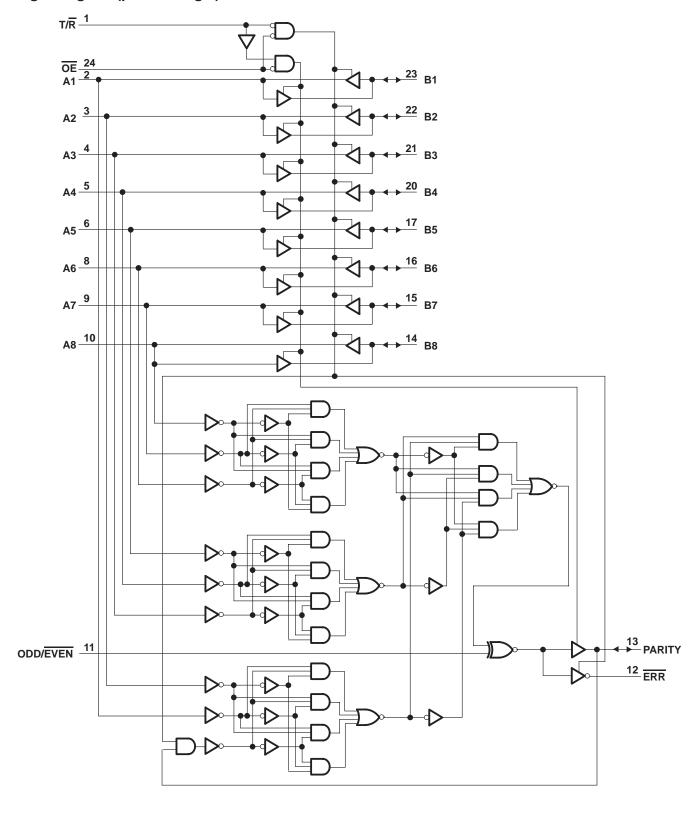
NUMBER OF A OR B		INPU	JTS	INPUT/OUTPUT	OUTPUTS		
INPUTS THAT ARE HIGH	OE	T/R	ODD/EVEN	PARITY	ERR	OUTPUT MODE	
	L	Н	Н	Н	Z	Transmit	
	L	Н	L	L	Z	Transmit	
0.04.00	L	L	Н	Н	Н	Receive	
0, 2, 4, 6, 8	L	L	Н	L	L	Receive	
	L	L	L	Н	L	Receive	
	L	L	L	L	Н	Receive	
	L	Н	Н	L	Z	Transmit	
	L	Н	L	Н	Z	Transmit	
4057	L	L	Н	Н	L	Receive	
1, 3, 5, 7	L	L	Н	L	Н	Receive	
	L	L	L	Н	Н	Receive	
	L	L	L	L	L	Receive	
Don't care	Н	Χ	Χ	Z	Z	Z	

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	$-0.5\;\mbox{V}$ to 7 \mbox{V}
Input voltage range, V _I (see Note 1)	$-0.5\ V$ to $7\ V$
Voltage range applied to any output in the disabled or power-off state, VO –	0.5 V to 5.5 V
Voltage range applied to any output in the high state, VO	-0.5 V to V _{CC}
Input clamp current, I _{IK} (V _I < 0)	30 mA
Current into any output in the low state, IO	128 mA
Operating free-air temperature range	. 0° C to 70° C
Storage temperature range	35°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 2)

			MIN	NOM	MAX	UNIT
Vcc	Supply voltage				5.5	V
VIH	High-level input voltage		2			V
VIL					8.0	V
lıK	Input clamp current				-18	mA
	I Park Level autout assessed	rel output current A port B port, PARITY, ERR			-3	4
ЮН	High-level output current				-15	mA
		A port			24	
lOL	Low-level output current	B port, PARITY, ERR			64	mA
TA	Operating free-air temperature				70	°C
			•			

NOTE 2: Unused or floating pins (input or I/O) must be held high or low.

NOTE 1: The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

SN74BCT657 OCTAL TRANSCEIVER WITH PARITY GENERATOR/CHECKER AND 3-STATE OUTPUTS SCBS079B - NOVEMBER 1991 - REVISED APRIL 1994

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CONDITIONS		MIN	TYP [†]	MAX	UNIT
٧ıĸ		V _{CC} = 4.5 V,	I _I = -18 mA				-1.2	V
	Any output	$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -3 \text{ mA}$		2.4	3.3		
∨он	B port, PARITY, ERR	$V_{CC} = 4.5 \text{ V},$	I _{OH} = -15 mA		2	3.1		V
	Any output	$V_{CC} = 4.75 \text{ V},$	IOH = -3 mA		2.7			
.,	A port	V _C C = 4.5 V,	I _{OL} = 24 mA			0.35	0.5	.,
VOL	B port, PARITY, ERR	V _C C = 4.5 V,	$I_{OL} = 64 \text{ mA}$			0.42	0.55	V
	T/R	$V_{CC} = 0$,	V _I = 7 V,	OE = 4.5 V			20	
	OE	V _C C = 0,	V _I = 7 V,	T/R = 4.5 V			20	
Ц	ODD/EVEN	$V_{CC} = 0$,	V _I = 7 V				20	μΑ
	A port	.,,					100	
	B port, PARITY	$V_{CC} = 5.5 \text{ V},$	$V_{ } = 5.5 \text{ V}$				200	
	A or B port, PARITY						200	
l _{IH} ‡	T/R, OE	V _{CC} = 5.5 V,	V _I = 2.7 V				20	μΑ
	ODD/EVEN						20	
	A or B port, PARITY						-70	
I _{IL} ‡	T/R, OE	V _{CC} = 5.5 V,	V _I = 0.5 V				-20	μΑ
	ODD/EVEN						-20	
	A port	.,			-60		-200	
los§	B port, PARITY, ERR	$V_{CC} = 5.5 \text{ V},$	$V_O = 0$		-125		-300	mA
lozh	ERR	V _C C = 5.5 V,	V _O = 2.7 V				50	μΑ
lozL	ERR	$V_{CC} = 5.5 \text{ V},$	$V_0 = 0.5 V$				-50	μΑ
ICCL		$V_{CC} = 5.5 \text{ V},$	Outputs open				90	mA
ICCH		V _{CC} = 5.5 V,	Outputs open				2	mA
Iccz		V _C C = 5.5 V,	Outputs open				1	mA
Ci	Control input	V _{CC} = 5 V,	V _I = 2.5 V or 0.5 V			6.5		pF
	A port		V _O = 2.5 V or 0.5 V			10		
C _{io}	B port, PARITY	$V_{CC} = 5 \text{ V},$			14			pF
Co	ERR	V _{CC} = 5 V,	V _O = 2.5 V or 0.5 V			10		pF

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current. § Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Note 3)

PARAMETER	FROM	то	V _{CC} = 5 V, T _A = 25°C			MIN	MAX	UNIT
	(INPUT)	(OUTPUT)	MIN	TYP	MAX			
t _{PLH}	A D	D as A	1.1	3.1	6	1.1	6.6	
t _{PHL}	A or B	B or A	2	5.3	8.5	2	9	ns
^t PLH	٨	DARITY	3	7.4	12.7	3	15.4	
t _{PHL}	А	PARITY	4.6	8.6	14.1	4.6	15.9	ns
^t PLH	ODD/EVEN	PARITY, ERR	1.1	4.1	6.4	1.1	7.1	
t _{PHL}	ODD/EVEN	PARITY, ERR	2.6	5.5	8.3	2.6	9	ns
^t PLH	6	ERR	3.1	7.4	12.6	3.1	15.3	
t _{PHL}	В	EKK	4.4	6.5	13.3	4.4	15.5	ns
^t PLH	DADITY	ERR	3.4	7.7	10.7	3.4	13.2	
^t PHL	PARITY	EKK	5.5	8.8	12	5.5	13.9	ns
^t PZH	ŌĒ	A D DADITY or FDD	1.8	5.1	7.7	1.8	9.1	
t _{PZL}	OE	A, B, PARITY, or ERR	3.2	6.7	14.2	2 3.2 16	16.3	ns
t _{PHZ}	- OE A	A, B, PARITY, or ERR	2.6	5.7	8	2.6	9.1	ns
t _{PLZ}		A, D, PARII I, UI ERR	2	5	7.4	2	8	110

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



PACKAGE OPTION ADDENDUM

18-Sep-2008

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp (3)
SN74BCT657DW	OBSOLETE	SOIC	DW	24	TBD	Call TI	Call TI
SN74BCT657DWR	OBSOLETE	SOIC	DW	24	TBD	Call TI	Call TI
SN74BCT657NT	OBSOLETE	PDIP	NT	24	TBD	Call TI	Call TI

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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NT (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

B. This drawing is subject to change without notice.

The 28 pin end lead shoulder width is a vendor option, either half or full width.



DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AD.



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